

# High Voltage Power MOSFET

# IXTY02N50D IXTU02N50D IXTP02N50D

1.13 / 10

0.35

0.40

3.00

Nm/lb.in.

g

g

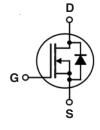
g

 $V_{DSX} = 500V$   $I_{D25} = 200mA$ 

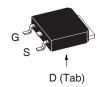
 $R_{DS(on)} \leq 30\Omega$ 

#### **N-Channel**

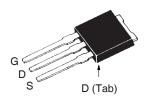
M<sub>d</sub> Weight



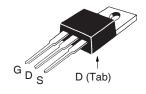
TO-252 (IXTY)



### TO-251 (IXTU)



### TO-220AB (IXTP)



G = Gate	D	= Drain
S = Source	Tab	= Drain

#### **Features**

- · Normally ON Mode
- International Standard Packages
- Low  $R_{DS(on)}$  HDMOS<sup>TM</sup> Process
- Rugged Polysilicon Gate Cell Structure
- · Fast Switching Speed

### **Advantages**

- · Easy to Mount
- Space Savings
- · High Power Density

#### **Applications**

- · Level Shifting
- Triggers
- · Solid State Relays
- Current Regulators

**Symbol Test Conditions Maximum Ratings** V<sub>DSX</sub>  $T_{\perp} = 25^{\circ}C$  to  $150^{\circ}C$ 500 ٧  $T_{\perp} = 25^{\circ}C$  to  $150^{\circ}C$ 500 V<sub>DGX</sub> ٧ V<sub>GSX</sub> Continuous ±20  $V_{GS\underline{M}}$ Transient ±30 ٧  $T_{c} = 25^{\circ}C$ 200  $I_{D25}$ mA  $T_{c} = 25^{\circ}C$ , Pulse Width Limited by T, 800 mΑ I<sub>DM</sub> **P**<sub>D</sub>  $T_{C} = 25^{\circ}C$   $T_{A} = 25^{\circ}C$ 25 W 1.1 W  $T_{J}$ - 55 ... +150 °С **T**<sub>JM</sub> 150 °С  $\mathsf{T}_{\underline{\mathsf{stg}}}$ - 55 ... +150  $^{\circ}\text{C}$ °С Maximum Lead Temperature for Soldering  $T_L$ 300 1.6 mm (0.062in.) from Case for 10s 260 ٥С  $\mathsf{T}_{\underline{\mathsf{SOLD}}}$ 

Symbol (T <sub>J</sub> = 25°C,	<b>Test Conditions</b> Unless Otherwise Specified)		Charac Min.	teristic Typ.	Values Max	
BV <sub>DSX</sub>	$V_{GS} = -10V, I_{D} = 25\mu A$		500			V
V <sub>GS(off)</sub>	$V_{DS} = 25V, I_{D} = 25\mu A$		- 2.5		- 5.0	V
I <sub>GSX</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$				±100	nA
I <sub>DSX(off)</sub>	$V_{DS} = V_{DSX}, V_{GS} = -10V$	T <sub>J</sub> = 125°C			10 250	μ <b>Α</b> μ <b>Α</b>
R <sub>DS(on)</sub>	$V_{GS} = 0V$ , $I_D = 50mA$ , Note 1			20	30	Ω
I <sub>D(on)</sub>	$V_{gs} = 0V, V_{DS} = 25V, Note 1$			250		mA

Mounting Torque (TO-220)

TO-252

TO-251

TO-220



<b>Symbo</b> (T <sub>J</sub> = 2		Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.
g <sub>fs</sub>		V <sub>DS</sub> = 50V, I <sub>D</sub> = 200mA, Note 1	100	150	mS
C <sub>iss</sub>	)			120	pF
$\mathbf{C}_{oss}$	}	$V_{GS} = -10V, V_{DS} = 25V, f = 1MHz$		25	pF
C <sub>rss</sub>	J			5	pF
t <sub>d(on)</sub>	)	Resistive Switching Times		9	ns
t <sub>r</sub>	ļ	$V_{gs} = \pm 5V, V_{ps} = 100V, I_{p} = 50mA$		4	ns
$\mathbf{t}_{d(off)}$				28	ns
t <sub>f</sub>		$R_{\rm G} = 30\Omega$ (External)		45	ns
R <sub>thJC</sub>		TO-220		0.50	5.0 °C/W °C/W

#### Source-Drain Diode

Symbol Test Conditions		<b>Characteristic Values</b>			
$(T_J = 25^{\circ}C)$	, Unless Otherwise Specified)	Min.	Тур.	Max.	
V <sub>SD</sub>	$I_F = 200 \text{mA}, V_{GS} = -10 \text{V}, \text{ Note 1}$		0.7	1.5	V
t <sub>rr</sub>	$I_F = 750 \text{mA}, -\text{di/dt} = 100 \text{A/} \mu \text{s}$ $V_R = 25 \text{V}, V_{GS} = -10 \text{V}$			1.0	μs

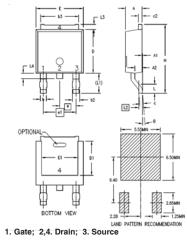
Note 1. Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ .



# IXTY02N50D

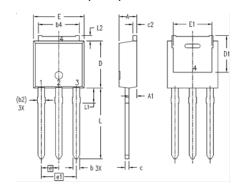
# IXTU02N50D IXTP02N50D

# TO-252 AA (IXTY) Outline



	INCH	IFS	MILLIMETERS		
MYZ	MIN	MAX	MIN	MAX	
Α	.086	.094	2.19	2.38	
A1	0	.005	0	0.12	
A2	.038	.046	0.97	1.17	
b	.025	.035	0.64	0.89	
b2 b3	.030	.045	0.76	1.14	
ь3	.200	.215	5.08	5.46	
С	.018	.024	0.46	0.61	
c2	.018	.023	0.46	0.58	
D	.235	.245	5.97	6.22	
D1	.180	.205	4.57	5,21	
Ε	.250	.265	6.35	6.73	
E1	.170	.205	4.32	5.21	
е	.090 BSC		2,28	BSC	
e1	.180 BSC		4.57	BSC	
Н	.370	.410	9.40	10.42	
L	.055	.070	1.40	1.78	
L1	.100	.115	2.54	2.92	
L2	.020 BSC		0.50	BSC	
L3	.025	.040	0.64	1.02	
L4	.025	.040	0.64	1.02	
θ	0°	10°	0°	10°	

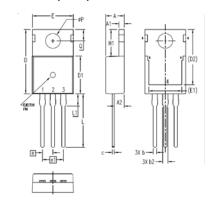
# TO-251 AA (IXTU) Outline



1. Gate; 2,4. Drain; 3. Source

SYM	INCH	INCHES		MILLIMETERS	
2114	MIN	MAX	MIN	MAX	
Α	.087	.094	2.20	2.40	
A1	.032	.048	0.82	1.22	
b	.026	.034	0.66	0.86	
(b2)	.030	.038	0.76	0.96	
b4	.198	.222	5.04	5.64	
С	.018	.024	0.45	0.60	
c2	.016	.024	0.40	0.60	
D	.232	.248	5.90	6.30	
(D1)	.179	.195	4.55	4.95	
E	.252	.268	6.40	6.80	
(E1)	.191	.207	4.85	5,25	
е	.090 BSC		2.28 BSC		
e1	.180 BSC		4.57	BSC	
L	.358	.374	9.10	9,50	
L1	.063	.079	1.60	2.00	
L2	.020	.035	0.50	0.90	

# TO-220 (IXTP) Outline



1. Gate; 2,4. Drain; 3. Source

SYM	INCHES		MILLIMETERS	
2114	MIN	MAX	MIN	MAX
Α	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
b	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
С	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
Ε	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
е	.100 BSC		2.54	BSC
e1	.200 BSC		5.08 BSC	
H1	.244	.268	6.20	6.80
L	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØΡ	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20

